

01) Bridelux: Vero 10 Vero SE 10 LED engines;

04) Edison: EdiLex III COB LED engines;
05) GE lighting: Infusion<sup>™</sup> LED engines;
06) LG Innotek: 7W, 10W LED engines;
07) LumiLEDS: LUXEON 1202/1203 LED engines;
08) Lumens: Ergon-COB 1304, 15xx LED engines;

Osram: SOLERIQ® S9 LED engines;
 Philips: Fortimo SLM LED engines;

02) Cree: XLamp CXA 13xx, Xlamp CXB 15xx Series engines;

09) Luminus: CXM-6, CHM/CLM/CXM-9 LED engines;

10) Nichia: NVxxx024Z,NVxxx036Z, NFCWxxxB Series LED engines;

Prolight Opto: PACJ-7xxx/14xxx/21xxx/28xxx-xxxx engines;
 Samsung: LCxxxC Series, LCxxxD Series LED engines;
 Seoul Semiconductor:SAWxxxxxx Series, DC COB LED engines;

17) Vossloh-Schwabe: LUGA Shop and LUGA C LED engines;

16) Tridonic: SLE G5, SLE G6 LES10mm LED engines;

03) Citizen: CLU026,CLU027,CLU028,CLU721,CLU711,CLU701 LED engines;

## Features & Benefits

\* Mechanical compatibility with direct mounting of the COB products to the

- LED thermal body and thermal performance matching the lumen packages.
- \* For Down light designs from 1200 to 1800 lumen.
- \* Thermal resistance range Rth 2.77°C/W.
- \* Full accessory kit with LED cooler Body, PSU mounting shrapnel & lens holder.
- \* Other accessories like COB holder & lens separate available.
- \* Modular design with mounting holes foreseen for direct mounting of a wide range of LED modules and COB's.
- \* Forged from highly conductive aluminum (ADC12) .
- \* Diameter 110mm Standard height 120mm, Other heights on request.
- \* 3 standard colors white powder, black powder and gray powder.



#### Order Information





- Notes: - Mentioned models are an extraction of full product range.
- For specific mechanical adaptations please contact MingfaTech.
- MingfaTech reserves the right to change products or specifications without prior notice.

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### The product deta table

	orbit
Model No.	Orbit-120
Heatsink Size	Ф110×Н120mm
Heatsink Material	ADC12
Heatsink Finish	White/Black/Gray
Weight	488g
Dissipated power (Ths-amb,50°C)	15 (W)
Beam Angle	50°
Thermal Resistance (Rhs-amb)	2.77(°C/W)

\* 3D files are avaliable in ParaSolid, STP and IGS on request

\* The thermal resistance Rth is determined with a calibrated heat source of 16mm×16mm central placed on the heat sink, Tamb 40° and an open environment. Reference data @ heat sink to ambient temperature rise Ths-amb 50°C

The thermal resistance of a LED cooler is not a fix value and will vary with the applied dissipated power Pd

\* Dissipated power Pd. Reference data @ heat sink to ambient temperature rise Ths-amb 50°C The maximal dissipated power needs to be verified in function of required case temperature Tc or junction temperature Tj and related to the estimated ambient temperature where the light fixture will be placed Please be aware the dissipated power Pd is not the same as the electrical power Pe of a LED module

To calculate the dissipated power please use the following formula: Pd = Pe x (1- $\eta$ L) Pd - Dissipated power Pe - Electrical power  $\eta$ L = Light effciency of the LED module







# **Drawings & Type Selection**

Туре	Dia.(mm)	Height(mm)	Power(w)	LES(mm)	Beam Angle	Cut-out(mm)
Orbit-120	110	120	15	11	50°	N/A





### **Components introduction**

1.Remove the reflector, Install the COB 2. Fix the COB by the holder and screw





4. The three notches of the lid are positioned on the three semicircular columns of the radiator



Tel:+86-769-39023131 E-fax:+86-(020)28819702 ext:22122 Email:sales@mingfatech.com Http://www.heatsinkled.com Http://www.mingfatech.com 3.Vertically align the shrapnel and press down on the reflector assembly



5. Press the outer plane of the bottom cover by hand, and rotate the cover counterclockwise to put it in position.







The thermal data table

			Heat sink to ambient	Heat sink to ambient	[	Heat si	
	Pd=Pe x (1-ηL)		Pd=Pe x thermal resistance tempe		()	70	
		• •	Orbit-120		ambient (°C)		
	۷)	2	3.70	7.8	Ibier	55	
	Pd(V	5	3.22	17.1		40	
	ver	10	2.91	31.1	above	40	
	I Pov	15	2.77	44.5		25	
	ated	18	2.71	52.3	sink rise	23	
	Dissipated Power Pd(W)	20	2.67	57.4	at si	10	
ä	Di	25	2.55	68.8	Heat	10	



\* Please be aware the dissipated power Pd is not the same as the electrical power Pe of a LED module.

\*To calculate the dissipated power please use the following formula:  $Pd = Pe x (I - \eta L)$ .

Pd - Dissipated power ; Pe - Electrical power ;  $\eta L$  = Light effciency of the LED module;

\*The aluminum substrate side of the package outer shell is thermally connected to the heat sink via TIM (Thermal interface material).

MingFa recommends the use of a high thermal conductive interface between the LED module and the LED cooler.

Either thermal grease, A thermal pad or a phase change thermal pad thickness 0.1-0.15mm is recommended.



\*Thermal resistance is a heat property and a measurement of a temperature difference by which an object or material resists a heat flow. Geometric shapes are different, the thermal resistance is different. Formula:  $\theta = (Ths - Ta)/Pd$   $\theta$  - Thermal Resistance [°C/W]; Ths - Heatsink temperature; Ta - Ambient temperature; \*The thermal resistance between the junction section of the light-emitting diode and the aluminum substrate side of the package outer shell is R<sub>junction-case</sub>, the thermal resistance of the TIM outside the package is R<sub>interface (TIM)</sub> [°C/W], the thermal resistance with the heat sink is R<sub>heatsink-ambient</sub> [°C/W], and the ambient temperature is T<sub>ambient</sub> [°C]. \*Thermal resistances outside the package R<sub>interface (TIM)</sub> and R<sub>heatsink-ambient</sub> can be integrated into the thermal resistance R<sub>case-ambient</sub> at this point.Thus, the following formula is also used: T<sub>junction</sub>=(R<sub>junction-case</sub> + R<sub>case-ambient</sub>)·Pd+T<sub>ambient</sub>

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